

**MG12300D-BN2MM Series 300A Dual IGBT**



**Features**

- High short circuit capability, self limiting short circuit current
- IGBT<sup>3</sup> CHIP(Trench+Field Stop technology)
- $V_{CE(sat)}$  with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Low switching losses

**Applications**

- Motor drives
- Inverter
- Converter
- SMPS and UPS
- Welder
- Induction Heating

**Agency Approvals**

AGENCY	AGENCY FILE NUMBER
	E71639

**Module Characteristics ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)**

Symbol	Parameters	Test Conditions	Min	Typ	Max	Unit
$T_{J(max)}$	Max. Junction Temperature				150	$^\circ\text{C}$
$T_{J(op)}$	Operating Temperature		-40		125	$^\circ\text{C}$
$T_{stg}$	Storage Temperature		-40		125	$^\circ\text{C}$
$V_{isol}$	Insulation Test Voltage	AC, t=1min		3000		V
CTI	Comparative Tracking Index	Module case exposed to 0.1% ammonium chloride solution per UL and IEC standards	350			V
Torque	Module-to-Sink	Recommended (M6)	3		5	N·m
Torque	Module Electrodes	Recommended (M6)	2.5		5	N·m
Weight				320		g

**Absolute Maximum Ratings ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)**

Symbol	Parameters	Test Conditions	Values	Unit
<b>IGBT</b>				
$V_{CES}$	Collector - Emitter Voltage	$T_J=25^\circ\text{C}$	1200	V
$V_{GES}$	Gate - Emitter Voltage		$\pm 20$	V
$I_C$	DC Collector Current	$T_c=25^\circ\text{C}$	480	A
		$T_c=80^\circ\text{C}$	300	A
$I_{CM}$	Repetitive Peak Collector Current	$t_p=1\text{ms}$	600	A
$P_{tot}$	Power Dissipation Per IGBT		1450	W
<b>Diode</b>				
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current	$T_c=25^\circ\text{C}$	480	A
		$T_c=80^\circ\text{C}$	300	A
$I_{FRM}$	Repetitive Peak Forward Current	$t_p=1\text{ms}$	600	A
$I^2t$		$T_J = 125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	18000	$\text{A}^2\text{s}$

Life Support Note:

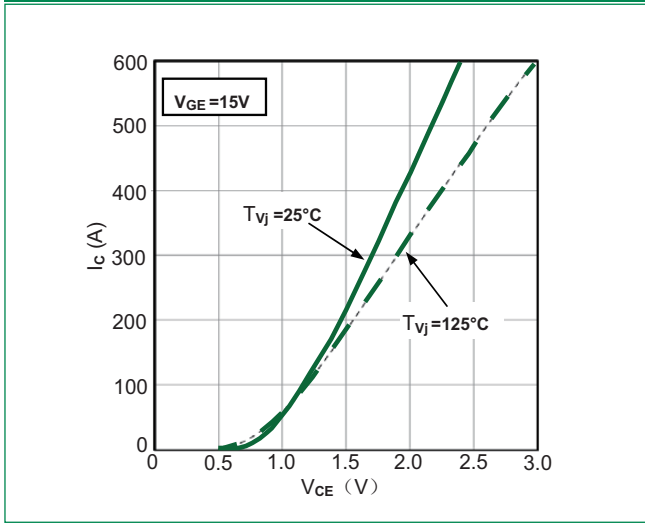
**Not Intended for Use in Life Support or Life Saving Applications**

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

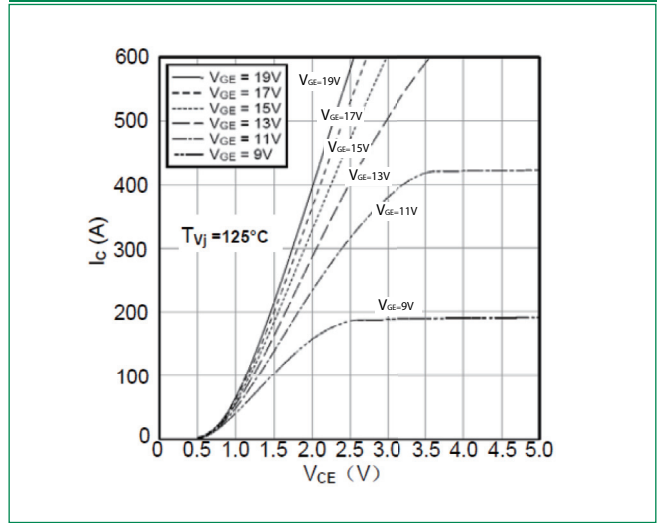
### Electrical and Thermal Specifications ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

Symbol	Parameters	Test Conditions	Min	Typ	Max	Unit
<b>IGBT</b>						
$V_{GE(th)}$	Gate - Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=12\text{mA}$	5.0	5.8	6.5	V
$V_{CE(sat)}$	Collector - Emitter Saturation Voltage	$I_C=300\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.7		V
		$I_C=300\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		1.9		V
$I_{CES}$	Collector Leakage Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	mA
		$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$			5	mA
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 15\text{V}, T_J=125^\circ\text{C}$	-400		400	$\mu\text{A}$
$R_{Gint}$	Intergrated Gate Resistor			2.5		$\Omega$
$Q_{ge}$	Gate Charge	$V_{CE}=600\text{V}, I_C=300\text{A}, V_{GE}=\pm 15\text{V}$		2.8		$\mu\text{C}$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		21		nF
$C_{res}$	Reverse Transfer Capacitance			0.85		nF
$t_{d(on)}$	Turn - on Delay Time	$V_{CC}=600\text{V}$ $I_C=300\text{A}$ $R_G=2.4\Omega$ $V_{GE}=\pm 15\text{V}$ Inductive Load	$T_J=25^\circ\text{C}$		160	ns
			$T_J=125^\circ\text{C}$		170	ns
$t_r$	Rise Time		$T_J=25^\circ\text{C}$		40	ns
			$T_J=125^\circ\text{C}$		45	ns
$t_{d(off)}$	Turn - off Delay Time		$T_J=25^\circ\text{C}$		450	ns
			$T_J=125^\circ\text{C}$		520	ns
$t_f$	Fall Time		$T_J=25^\circ\text{C}$		100	ns
			$T_J=125^\circ\text{C}$		160	ns
$E_{on}$	Turn - on Energy		$T_J=25^\circ\text{C}$		16.5	mJ
			$T_J=125^\circ\text{C}$		25	mJ
$E_{off}$	Turn - off Energy	$T_J=25^\circ\text{C}$		24.5	mJ	
		$T_J=125^\circ\text{C}$		37	mJ	
$I_{SC}$	Short Circuit Current	$t_{psc}\leq 10\mu\text{s}, V_{GE}=15\text{V}$		1200		A
		$T_J=125^\circ\text{C}, V_{CC}=900\text{V}$				
$R_{thJC}$	Junction-to-Case Thermal Resistance (Per IGBT)				0.085	K/W
<b>Diode</b>						
$V_F$	Forward Voltage	$I_F=300\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.65		V
		$I_F=300\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.65		V
$I_{RRM}$	Max. Reverse Recovery Current	$I_F=300\text{A}, V_R=600\text{V}$		270		A
$Q_{rr}$	Reverse Recovery Charge	$d_I/dt=-6000\text{A}/\mu\text{s}$		56		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy	$T_J=125^\circ\text{C}$		26		mJ
$R_{thJCD}$	Junction-to-Case Thermal Resistance (Per Diode)			0.15		K/W

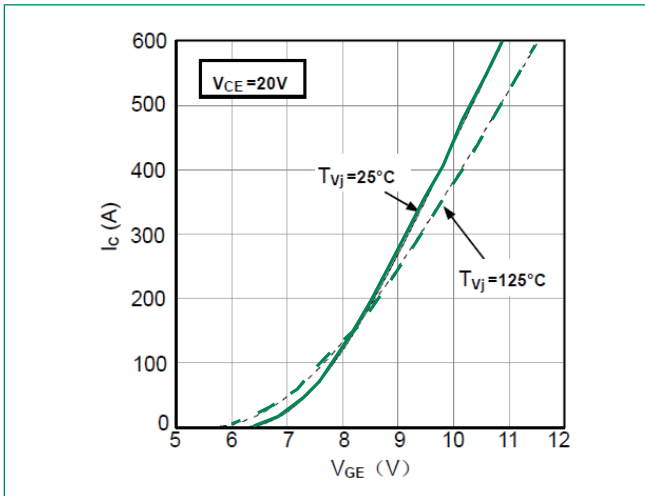
**Figure 1: Typical Output Characteristics**



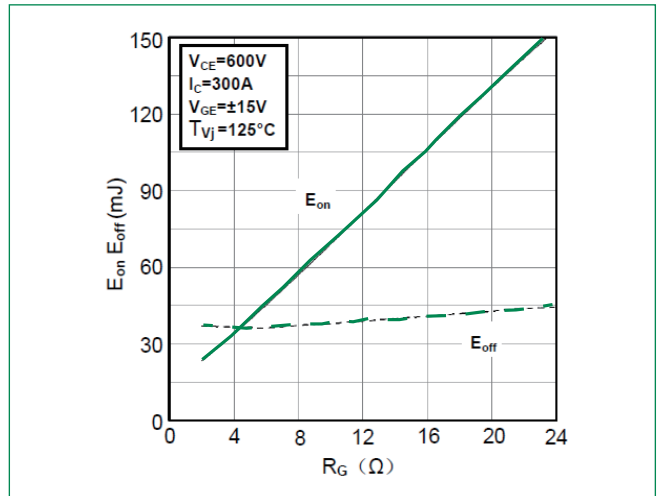
**Figure 2: Typical Output Characteristics**



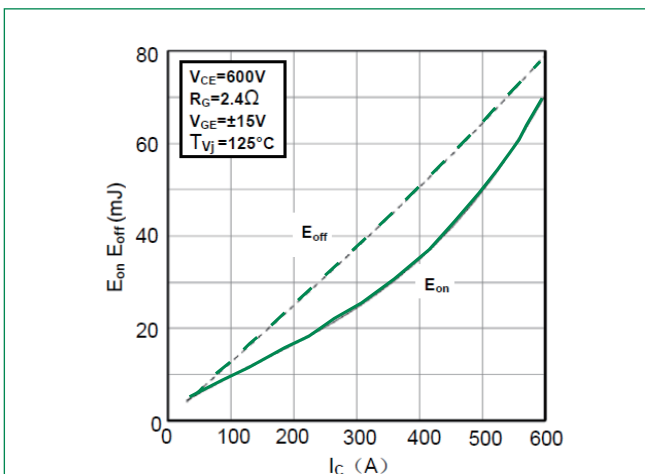
**Figure 3: Typical Transfer characteristics**



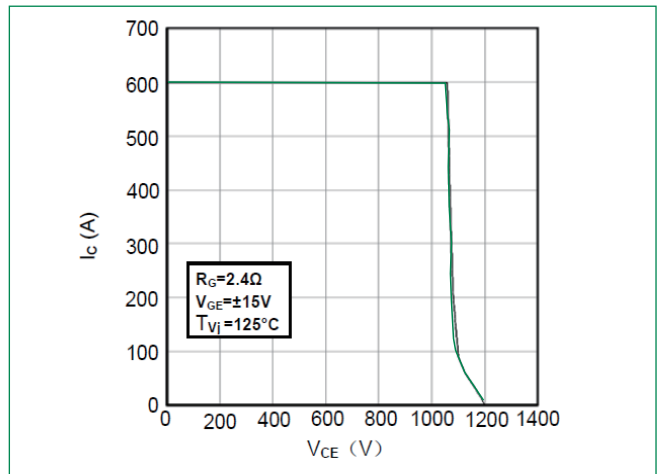
**Figure 4: Switching Energy vs. Gate Resistor**



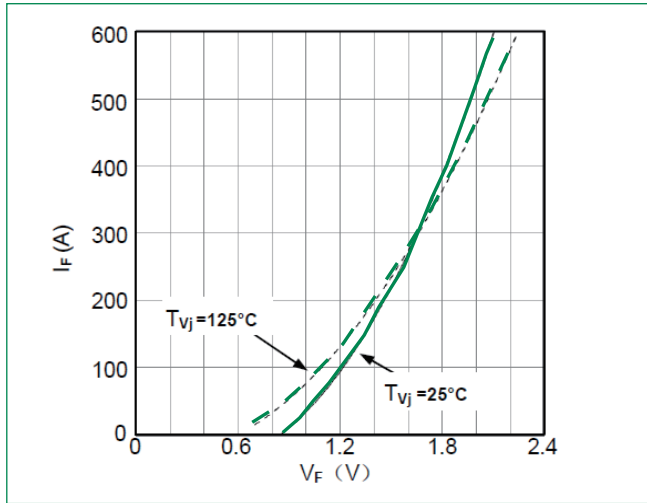
**Figure 5: Switching Energy vs. Collector Current**



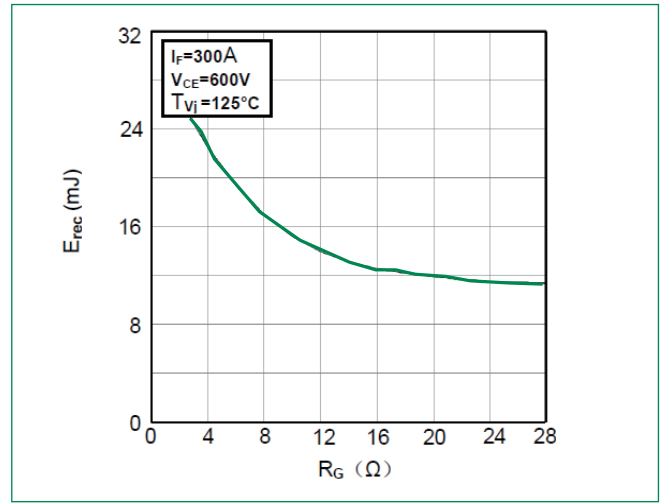
**Figure 6: Reverse Biased Safe Operating Area**



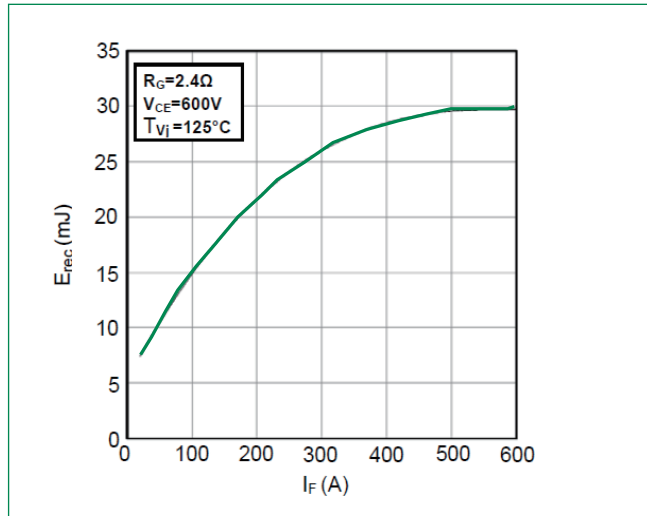
**Figure 7: Diode Forward Characteristics**



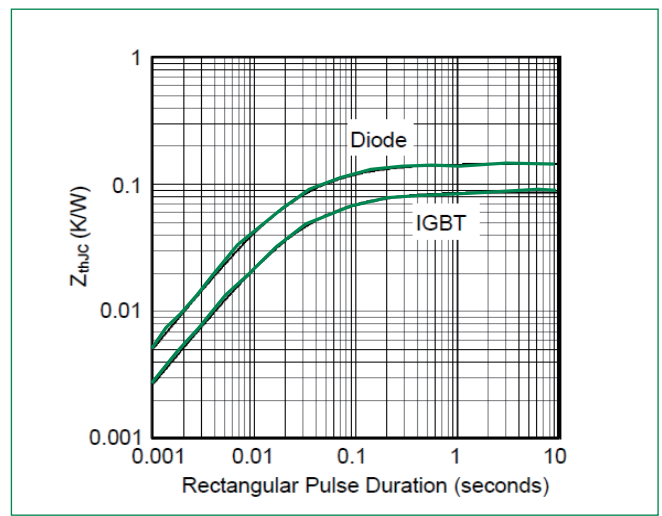
**Figure 8: Switching Energy vs. Gate Resistort**



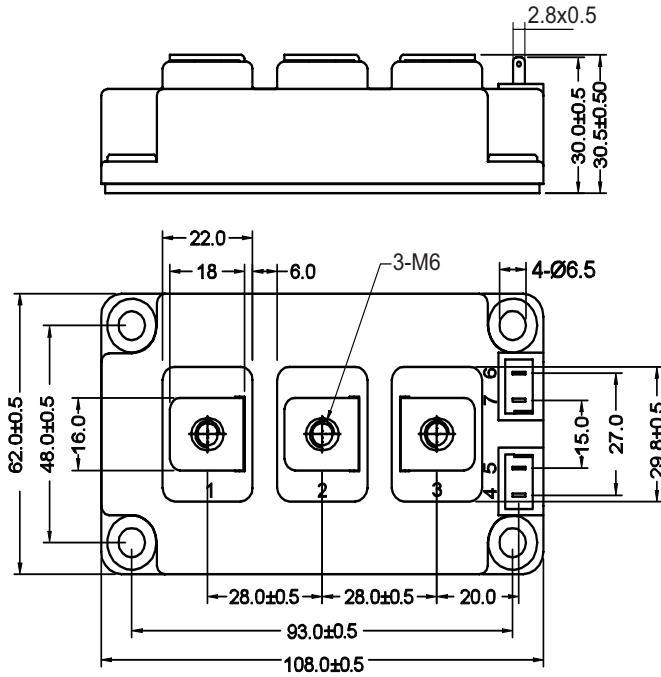
**Figure 9: Switching Energy vs. Forward Current**



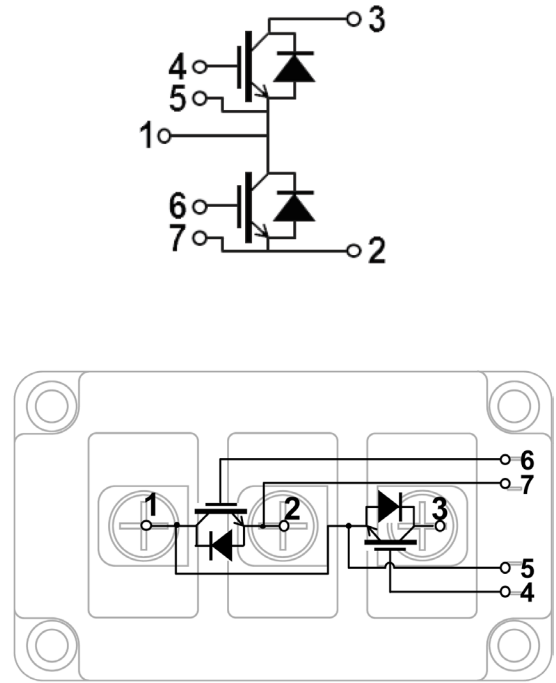
**Figure 10: Transient Thermal Impedance**



**Dimensions-Package D**



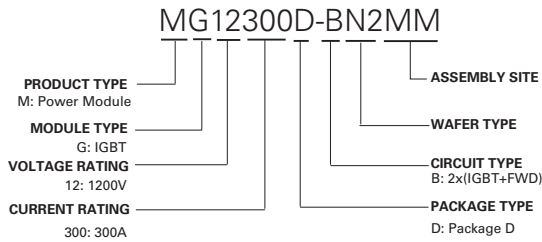
**Circuit Diagram and Pin Assignment**



**Packing Options**

Part Number	Marking	Weight	Packing Mode	M.O.Q
MG12300D-BN2MM	MG12300D-BN2MM	320g	Bulk Pack	60

**Part Numbering System**



**Part Marking System**

